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PRMH2

50 V, 100 mA NPN/NPN Resistor-Equipped double Transistors (RET)

27 July 2017

Product data sheet

1. General description

NPN/NPN Resistor-Equipped double Transistors (RET) in an ultra small DFN1412-6 (SOT1268) leadless Surface-Mounted Device (SMD) plastic package.

NPN/PNP complement: PRMD12.

2. Features and benefits

- 100 mA output current capability
- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place costs
- Low package height of 0.5 mm
- AEC-Q101 qualified

3. Applications

- Digital applications
- Cost-saving alternative to BC847/BC857 series in digital applications
- Control of IC inputs
- Switching loads

4. Quick reference data

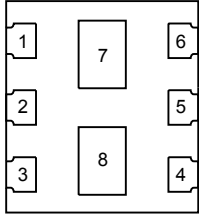
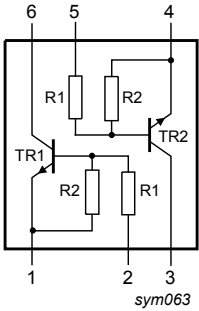
Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------------------|---------------------------|------------------------------------------------------------------------------|-----|-----|-----|---------------|
| Per transistor | | | | | | |
| V_{CEO} | collector-emitter voltage | open base | - | - | 50 | V |
| I_O | output current | | - | - | 100 | mA |
| h_{FE} | DC current gain | $V_{CE} = 5\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ }^\circ\text{C}$ | 80 | - | - | |
| R1 | bias resistor 1 | $T_{amb} = 25\text{ }^\circ\text{C}$ | [1] | 33 | 47 | 61 k Ω |
| R2/R1 | bias resistor ratio | | [1] | 0.8 | 1 | 1.2 |

[1] See section "Test information" for resistor calculation and test conditions.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|------------------------|----------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------|
| 1 | GND1 | GND (emitter) TR1 |  <p>Transparent top view DFN1412-6 (SOT1268)</p> |  <p><i>sym063</i></p> |
| 2 | I1 | input (base) TR1 | | |
| 3 | O2 | output (collector) TR2 | | |
| 4 | GND2 | GND (emitter) TR2 | | |
| 5 | I2 | input (base) TR2 | | |
| 6 | O1 | output (collector) TR1 | | |
| 7 | O1 | output (collector) TR1 | | |
| 8 | O2 | output (collector) TR2 | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package | | |
|-------------|-----------|-------------------------------------------------------------------------------------------------------------------|---------|
| | Name | Description | Version |
| PRMH2 | DFN1412-6 | plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body: 1.4 mm x 1.2 mm x 0.47 mm | SOT1268 |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PRMH2 | C2 |

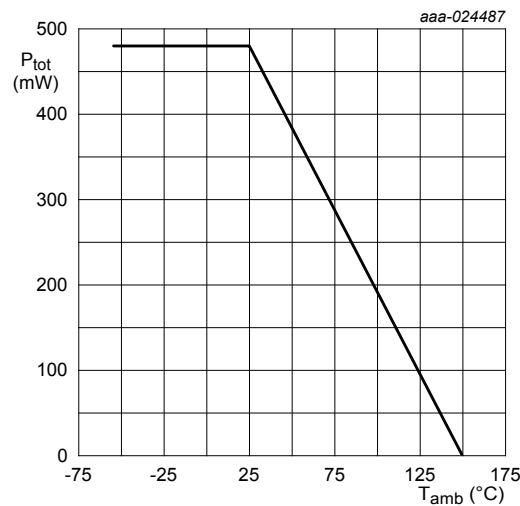
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|-----------------------|---------------------------|-----------------------------|-----|-----|-----|------|
| Per transistor | | | | | | |
| V_{CBO} | collector-base voltage | open emitter | | - | 50 | V |
| V_{CEO} | collector-emitter voltage | open base | | - | 50 | V |
| V_{EBO} | emitter-base voltage | open collector | | - | 10 | V |
| V_I | input voltage | positive | | - | 40 | V |
| | | negative | | - | -10 | V |
| I_O | output current | | | - | 100 | mA |
| P_{tot} | total power dissipation | $T_{amb} \leq 25\text{ °C}$ | [1] | - | 325 | mW |
| Per device | | | | | | |
| P_{tot} | total power dissipation | $T_{amb} \leq 25\text{ °C}$ | [1] | - | 480 | mW |
| T_j | junction temperature | | | - | 150 | °C |
| T_{amb} | ambient temperature | | | -55 | 150 | °C |
| T_{stg} | storage temperature | | | -65 | 150 | °C |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



FR4 PCB, standard footprint

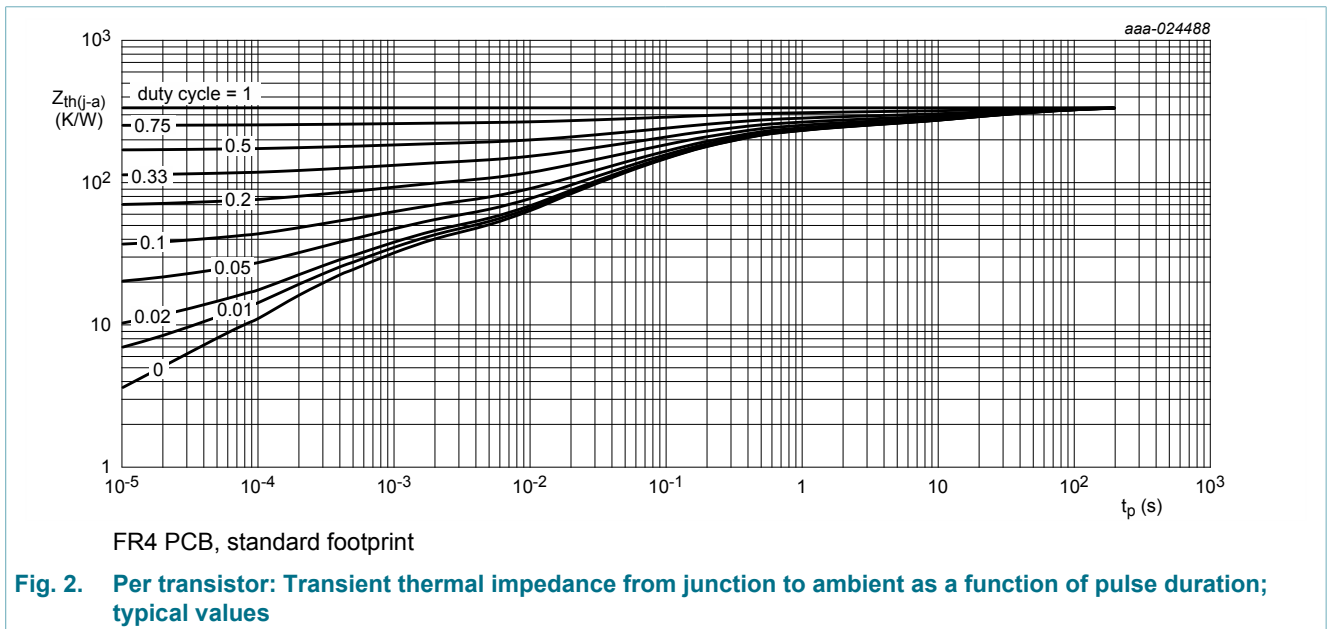
Fig. 1. Per device: Power derating curve

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Typ | Max | Unit |
|-----------------------|---------------------------------------------|-------------|-----|-----|-----|-----|------|
| Per transistor | | | | | | | |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | - | 385 | K/W |
| Per device | | | | | | | |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | - | 261 | K/W |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

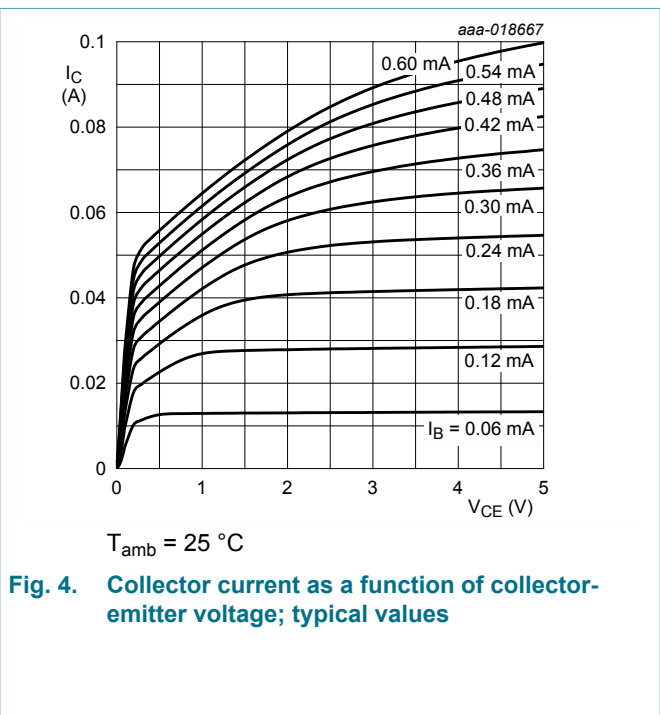
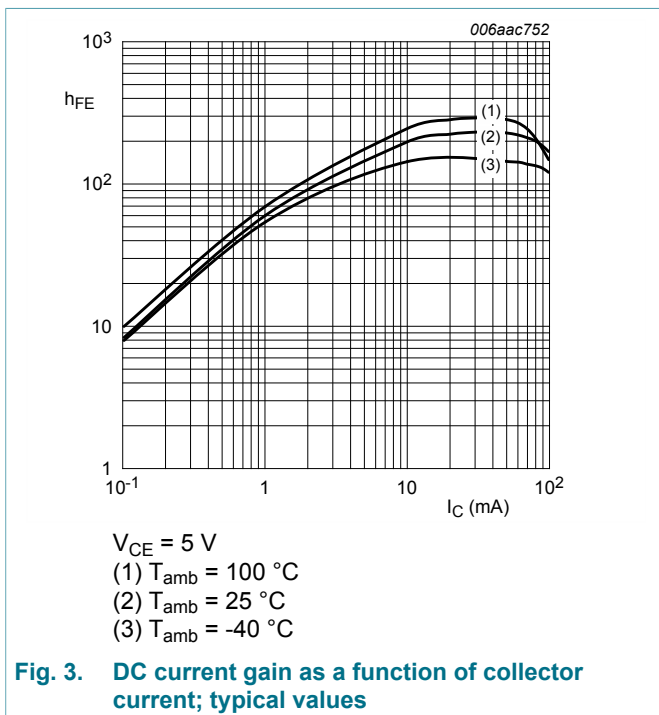


10. Characteristics

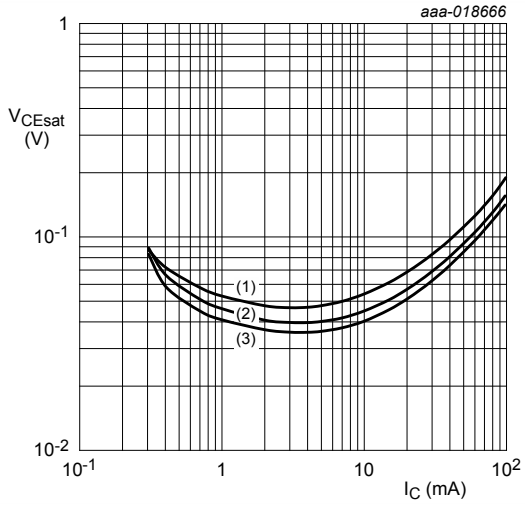
Table 7. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|-----------------------|-----------------------------------------------|------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|------------|
| Per transistor | | | | | | | |
| I_{CBO} | collector-base cut-off current (emitter open) | $V_{CB} = 50\text{ V}; I_E = 0\text{ A}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | - | 100 | nA | |
| I_{CEO} | collector-emitter cut-off current (base open) | $V_{CE} = 30\text{ V}; I_B = 0\text{ A}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | - | 1 | μA | |
| | | $V_{CE} = 30\text{ V}; I_B = 0\text{ A}; T_j = 150\text{ }^\circ\text{C}$ | - | - | 5 | μA | |
| I_{EBO} | emitter-base cut-off current (collector open) | $V_{EB} = 5\text{ V}; I_C = 0\text{ A}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | - | 90 | μA | |
| h_{FE} | DC current gain | $V_{CE} = 5\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ }^\circ\text{C}$ | 80 | - | - | | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 10\text{ mA}; I_B = 0.5\text{ mA}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | - | 150 | mV | |
| $V_{I(off)}$ | off-state input voltage | $V_{CE} = 5\text{ V}; I_C = 100\text{ }\mu\text{A}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | 1.2 | 0.8 | V | |
| $V_{I(on)}$ | on-state input voltage | $V_{CE} = 0.3\text{ V}; I_C = 2\text{ mA}; T_{amb} = 25\text{ }^\circ\text{C}$ | 3 | 1.6 | - | V | |
| R1 | bias resistor 1 | $T_{amb} = 25\text{ }^\circ\text{C}$ | [1] | 33 | 47 | 61 | k Ω |
| R2/R1 | bias resistor ratio | | [1] | 0.8 | 1 | 1.2 | |
| C_C | collector capacitance | $V_{CB} = 10\text{ V}; I_E = 0\text{ A}; i_e = 0\text{ A}; f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | - | - | 2.5 | pF | |
| f_T | transition frequency | $V_{CE} = 5\text{ V}; I_C = 10\text{ mA}; f = 100\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | [2] | 230 | - | MHz | |

- [1] See section "Test information" for resistor calculation and test conditions.
- [2] Characteristics of built-in transistor

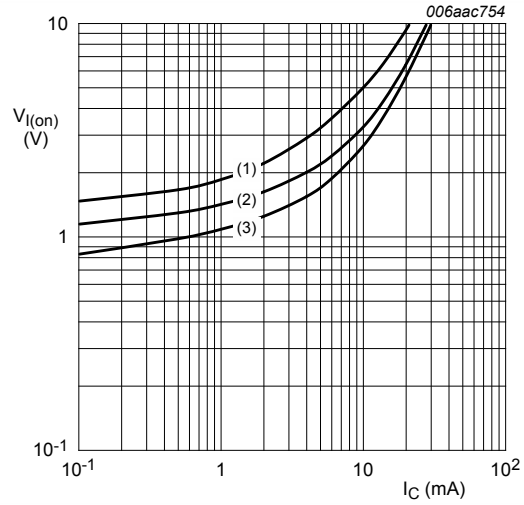


50 V, 100 mA NPN/NPN Resistor-Equipped double Transistors (RET)



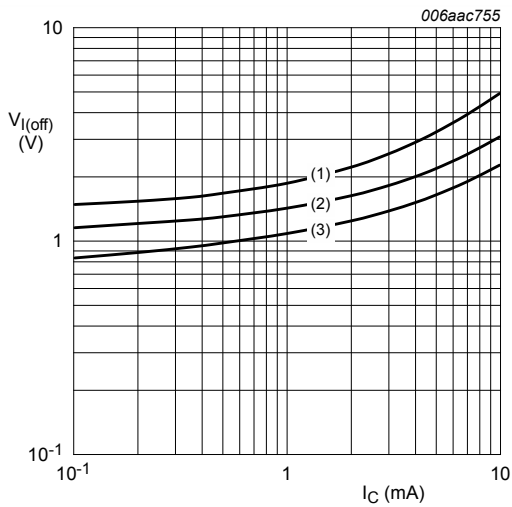
$I_C/I_B = 20$
 (1) $T_{amb} = 100\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = -40\text{ }^\circ\text{C}$

Fig. 5. Collector-emitter saturation voltage as a function of collector current; typical values



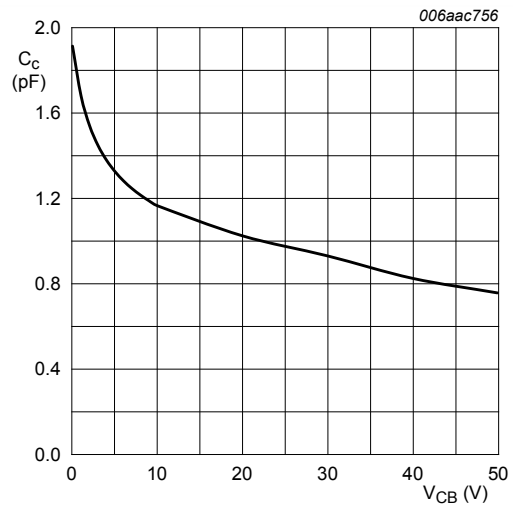
$V_{CE} = 0.3\text{ V}$
 (1) $T_{amb} = -40\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = 100\text{ }^\circ\text{C}$

Fig. 6. On-state input voltage as a function of collector current; typical values



$V_{CE} = 5\text{ V}$
 (1) $T_{amb} = -40\text{ }^\circ\text{C}$
 (2) $T_{amb} = 25\text{ }^\circ\text{C}$
 (3) $T_{amb} = 100\text{ }^\circ\text{C}$

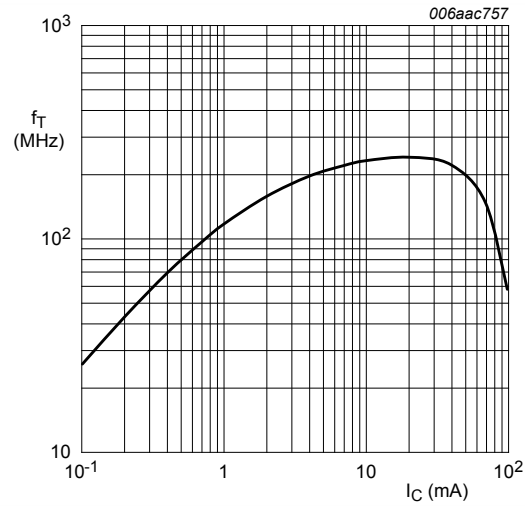
Fig. 7. Off-state input voltage as a function of collector current; typical values



$f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

Fig. 8. Collector capacitance as a function of collector-base voltage; typical values

50 V, 100 mA NPN/NPN Resistor-Equipped double Transistors (RET)



$V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

Fig. 9. Transition frequency as a function of collector current; typical values of built-in transistor

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

Resistor calculation

- Calculation of bias resistor 1 (R1)

$$R1 = \frac{V(I12) - V(I11)}{I12 - I11}$$

- Calculation of bias resistor ratio (R2/R1)

$$\frac{R2}{R1} = \frac{V(I14) - V(I13)}{R1 \cdot (I14 - I13)} - 1$$

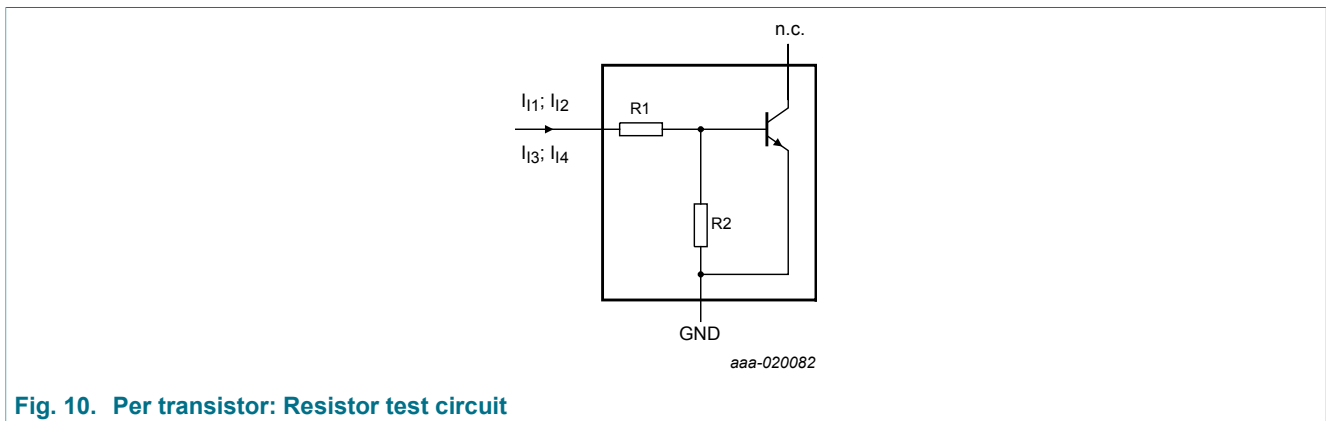


Fig. 10. Per transistor: Resistor test circuit

Resistor test conditions

Table 8. Resistor test conditions

| R1 (kΩ) | R2 (kΩ) | Test conditions | | | |
|---------|---------|-----------------|-----------------|-----------------|-----------------|
| | | I ₁₁ | I ₁₂ | I ₁₃ | I ₁₄ |
| 47 | 47 | 55 μA | 105 μA | -55 μA | -105 μA |

12. Package outline

DFN1412-6: plastic thermal enhanced ultra thin small outline package; no leads;
6 terminals; body: 1.4 x 1.2 x 0.47 mm

SOT1268

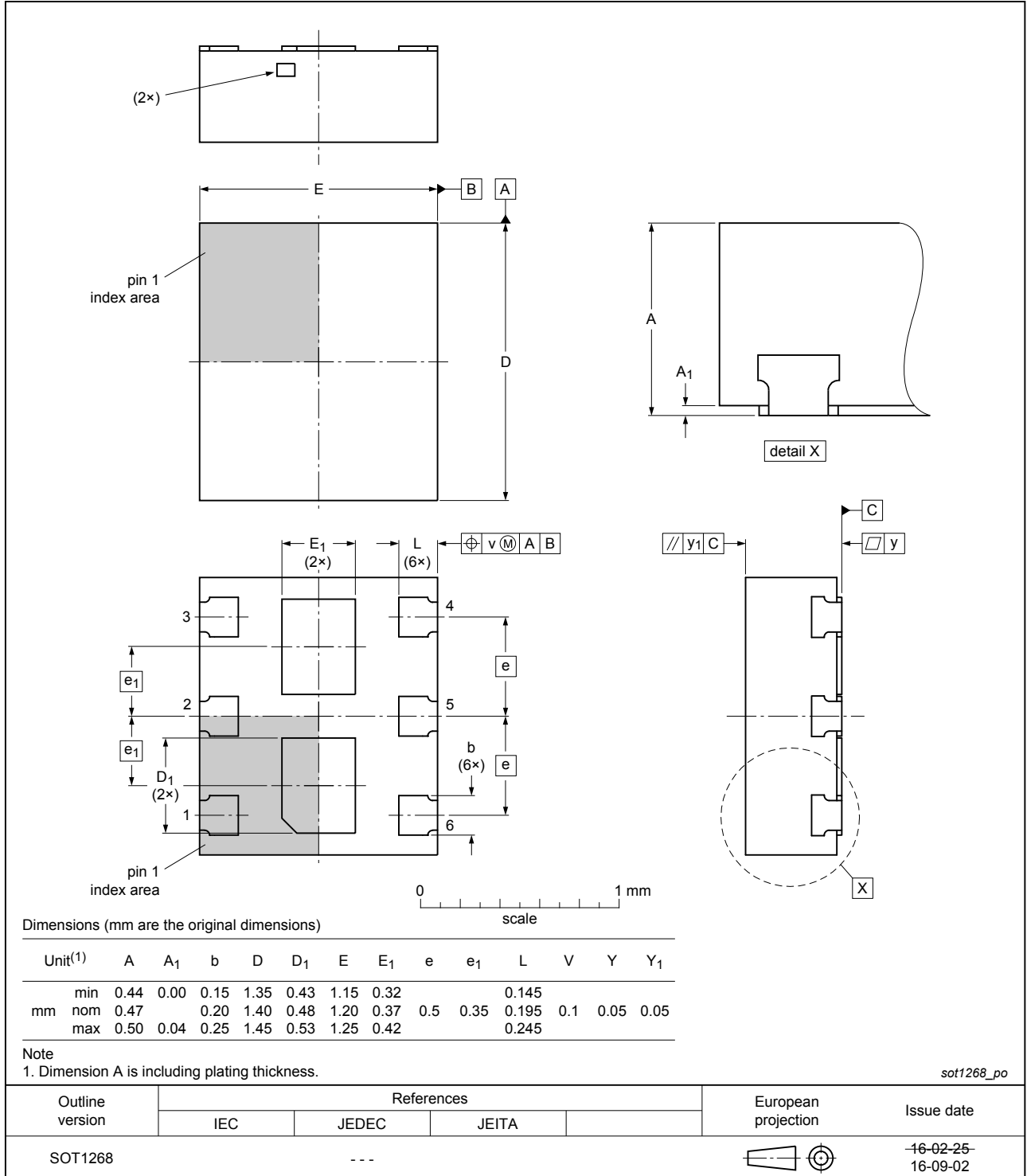


Fig. 11. Package outline DFN1412-6 (SOT1268)

13. Soldering

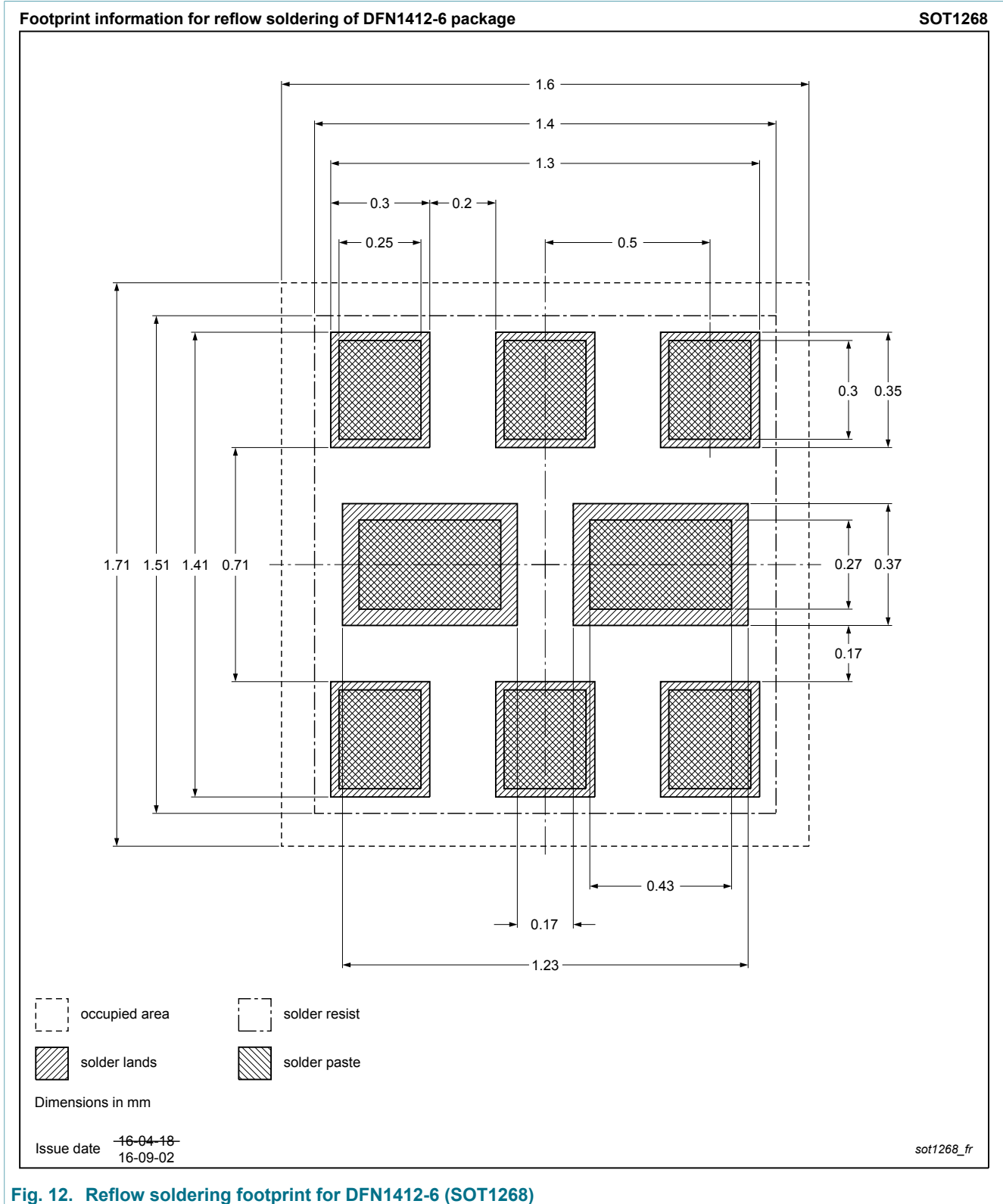


Fig. 12. Reflow soldering footprint for DFN1412-6 (SOT1268)

14. Revision history

Table 9. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|---------------|--------------|--------------------|---------------|------------|
| PRMH2 v.1 | 20170727 | Product data sheet | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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